MOSFET – Single, N-Channel, Small Signal, SOT-883 (XDFN3), 1.0 x 0.6 x 0.4 mm

20 V, 361 Ma

Features

- Single N-Channel MOSFET
- Ultra Low Profile SOT-883 (XDFN3) 1.0 x 0.6 x 0.4 mm for Extremely Thin Environments Such as Portable Electronics
- Low R_{DS(on)} Solution in the Ultra Small 1.0 x 0.6 mm Package
- 1.5 V Gate Drive
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- High Side Switch
- High Speed Interfacing
- Level Shift and Translate
- Optimized for Power Management in Ultra Portable Solutions

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

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Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	20	V	
Gate-to-Source Voltage			V _{GS}	±8	V	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	Ι _D	361	mA	
Current (Note 1)	State	$T_A = 85^{\circ}C$		260		
	t ≤ 5 s	$T_A = 25^{\circ}C$		427		
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	155	mW	
	t ≤ 5 s			217		
Pulsed Drain Current	t _p = 10 μs		I _{DM}	1082	mA	
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C	
Source Current (Body Diode) (Note 2)			۱ _S	129	mA	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using the minimum recommended pad size, or 2 mm², 1 oz Cu.

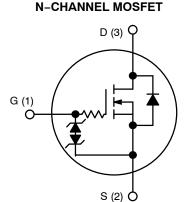
2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%

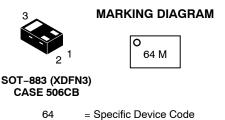


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V _{(BR)DSS}	R _{DS(on)} MAX	I _D Max
20 V	0.7 Ω @ 4.5 V	
	1.0 Ω @ 2.5 V	361 mA
	2.0 Ω @ 1.8 V	301 MA
	4.0 Ω @ 1.5 V	





= Date Code

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ORDERING INFORMATION

Device	Package	Shipping [†]
NTNS3164NZT5G	SOT-883 (Pb-Free)	8000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Junction-to-Ambient - Steady State (Note 3)	R_{\thetaJA}	806	°C/W
Junction-to-Ambient – t \leq 5 s (Note 3)	R_{\thetaJA}	575	C/W

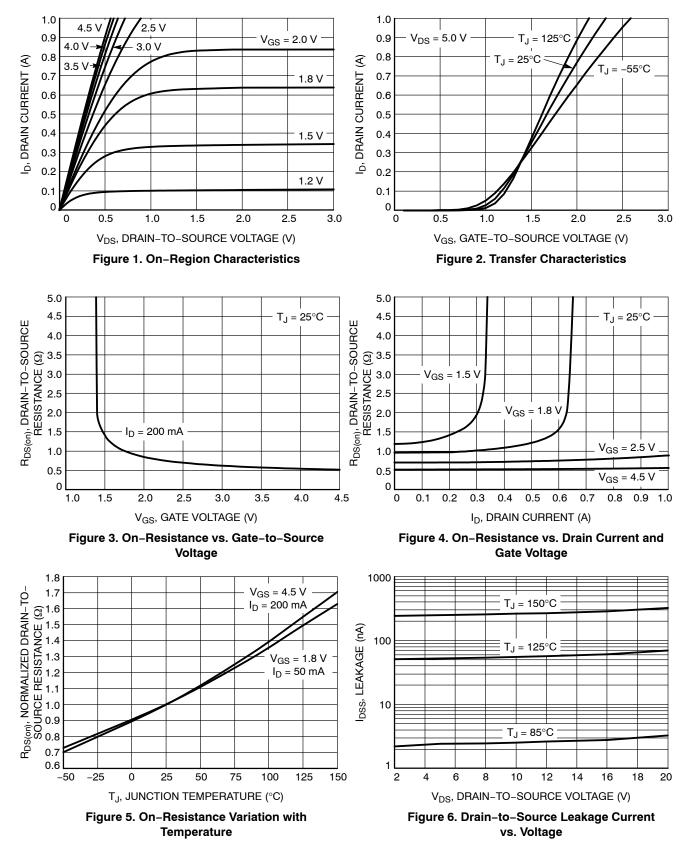
3. Surface-mounted on FR4 board using the minimum recommended pad size, or 2 mm², 1 oz Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

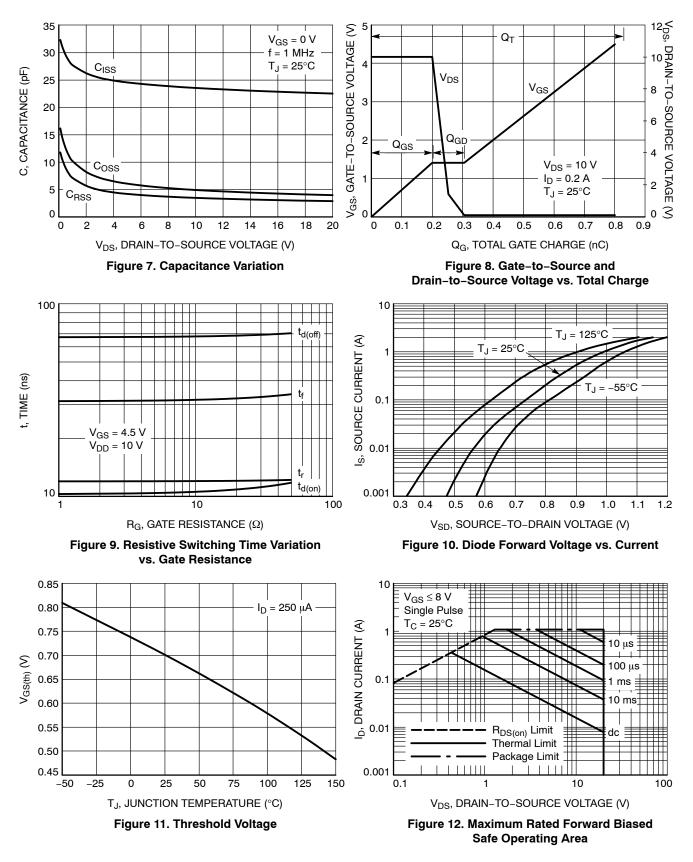
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•					
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_{D} = 250 μA	20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu A$, ref to $25^{\circ}C$		23		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 \text{ V}, \text{ V}_{DS} = 20 \text{ V} $ $T_J = 25^{\circ}\text{C}$			1	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 5 V			±10	μΑ
ON CHARACTERISTICS (Note 4)						-
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	0.4		1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J			1.8		mV/°C
Drain-to-Source On Resistance		V_{GS} = 4.5 V, I _D = 200 mA		0.5	0.7	Ω
		V_{GS} = 2.5 V, I _D = 100 mA		0.7	1.0	
	R _{DS(on)}	V _{GS} = 1.8 V, I _D = 50 mA		1.0	2.0	
		V _{GS} = 1.5 V, I _D = 10 mA		1.2	4.0	
Forward Transconductance	9 _{FS}	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$		1.26		S
Source-Drain Diode Voltage	V _{SD}	V_{GS} = 0 V, I _S = 100 mA		0.75	1.2	V
CHARGES & CAPACITANCES						
Input Capacitance	C _{ISS}			24		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, freq = 1 MHz, V_{DS} = 10 V		5.0		pF
Reverse Transfer Capacitance	C _{RSS}			3.4		
Total Gate Charge	Q _{G(TOT)}			0.8		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 10 V;		0.1		
Gate-to-Source Charge	Q _{GS}	I _D = 200 mA		0.2		nC
Gate-to-Drain Charge	Q _{GD}			0.1		
SWITCHING CHARACTERISTICS, VGS	6 = 4.5 V (Note	4)				
Turn-On Delay Time	t _{d(ON)}			10		
Rise Time	t _r	V _{GS} = 4.5 V, V _{DD} = 10 V,		11		1
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{DD} = 10 V, I_{D} = 200 mA, R_{G} = 2 Ω		67		ns
Fall Time	t _f			31		

4. Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

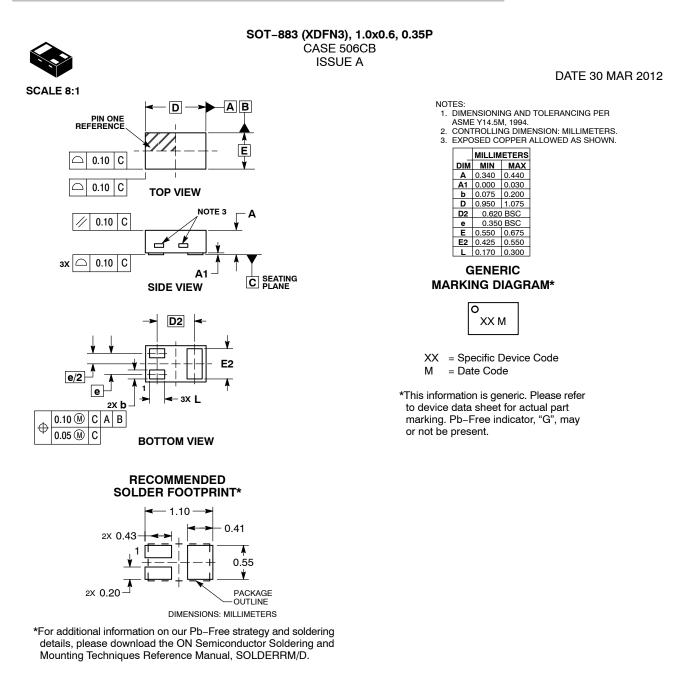


$R_{\theta JA} = 806^{\circ}C/W$ Steady State 900 R(t), EFFECTIVE TRANSIENT THER-800 +++++++ (%700 600 500 400 200 WAL RESPONSE (%C/%) 400 200 ŦŦŦŀ Duty Cycle = 0.5 0.01 -0.05 0.02 $| \rangle |$ 0.2 NIL 0.1 100 Single Pulse 0 1E-02 1E-05 1E-03 1E-06 1E-04 1E-01 1E+00 1E+01 1E+02 1E+03 t, TIME (s)

TYPICAL CHARACTERISTICS

Figure 13. FET Thermal Response





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